



AMENDMENT TRANSMITTAL LETTER					Docket No. 0941-0946PUS
Application No.		Filing Date April 22, 2004		Examiner	Art Un
10/829,363-Conf. #7073		April 22,	2004	H. V. Duong	2835
plicant(s): Chin	n-Cheng LIN				
rention: HOUSII	NG STRUCTU	RE			
S Amendment mmissioner for F D. Box 1450 exandria, VA 223					
ransmitted herev	with is an ame	ndment in the	above-identif	ied application.	
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	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
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A check in th	ne amount of \$		is enclo	sed.	
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x Charge a	ny additional fili	ng or application	n processing	fees required under 3	7 CFR 1.16 and 1.17
T. M.Y	in The	. 1		Dated:	June 12, 2006
Joe McKinney M Attorney Reg. N					
BIRCH, STEWA 8110 Gatehous Suite 100 East P.O. Box 747 Falls Church, V	e Road irginia 22040-		_P		
(703) 205-8026					



Docket No.: 0941-0946PUS1

Confirmation No.: 7073

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Chin-Cheng LIN

Application No.: 10/829,363

Filed: April 22, 2004 Art Unit: 2835

For: HOUSING STRUCTURE Examiner: H. V. Duong

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In reply to the Office Action dated March 10, 2006, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes:

Amendments to the Specification; and

Remarks.